



AA3527ASURS-50MAV

3.5 x 2.7 mm Surface Mount LED Lamp

DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- Single color
- Suitable for all SMD assembly and solder process
- Available on tape and reel
- Ideal for backlighting
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

APPLICATIONS

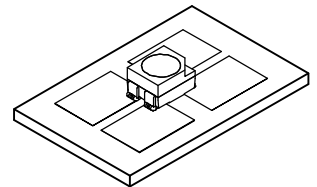
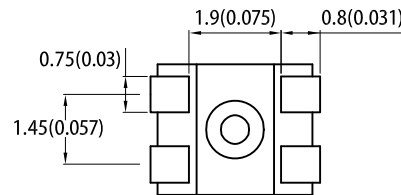
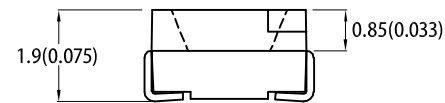
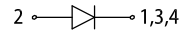
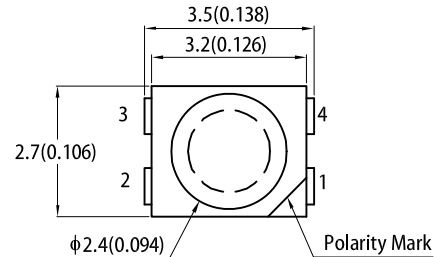
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

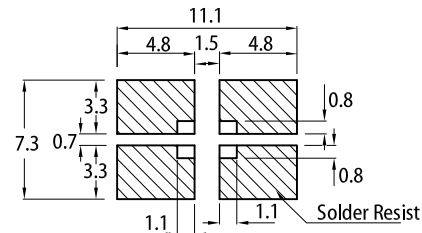


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 50mA ^[2]		Viewing Angle ^[1]
			Min.	Typ.	201/2
AA3527ASURS-50MAV	■ Hyper Red (AlGaInP)	Water Clear	500	950	120°
			*120	*280	

Notes:
1. $\theta_{1/2}$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: $\pm 15\%$.

* Luminous intensity value is traceable to CIE127-2007 standards.

ELECTRICAL / OPTICAL CHARACTERISTICS at $T_A=25^{\circ}\text{C}$

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission $I_F = 50\text{mA}$	λ_{peak}	Hyper Red	645	-	nm
Dominant Wavelength $I_F = 50\text{mA}$	$\lambda_{\text{dom}}^{[1]}$	Hyper Red	630	-	nm
Spectral Bandwidth at 50% Φ REL MAX $I_F = 50\text{mA}$	$\Delta\lambda$	Hyper Red	27	-	nm
Capacitance	C	Hyper Red	45	-	pF
Forward Voltage $I_F = 50\text{mA}$	$V_F^{[2]}$	Hyper Red	2.0	2.5	V
Reverse Current ($V_R = 5\text{V}$)	I_R	Hyper Red	-	10	uA
Temperature Coefficient of λ_{peak} $I_F = 50\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	$\text{TC}_{\lambda_{\text{peak}}}$	Hyper Red	0.14	-	nm/ $^{\circ}\text{C}$
Temperature Coefficient of λ_{dom} $I_F = 50\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	$\text{TC}_{\lambda_{\text{dom}}}$	Hyper Red	0.05	-	nm/ $^{\circ}\text{C}$
Temperature Coefficient of V_F $I_F = 50\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	TC_V	Hyper Red	-1.9	-	mV/ $^{\circ}\text{C}$

Notes:

1. The dominant wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance $\lambda_d : \pm 1\text{nm}$.)
2. Forward voltage: $\pm 0.1\text{V}$.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

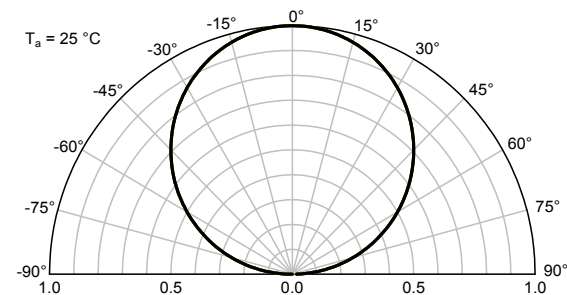
ABSOLUTE MAXIMUM RATINGS at $T_A=25^{\circ}\text{C}$

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	125	mW
Reverse Voltage	V_R	5	V
Junction Temperature	T_j	115	$^{\circ}\text{C}$
Operating Temperature	T_{op}	-40 to +85	$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-40 to +85	$^{\circ}\text{C}$
DC Forward Current	I_F	50	mA
Peak Forward Current	$I_{\text{FM}}^{[1]}$	185	mA
Electrostatic Discharge Threshold (HBM)	-	3000	V
Thermal Resistance (Junction / Ambient)	$R_{\text{th JA}}^{[2]}$	265	$^{\circ}\text{C/W}$
Thermal Resistance (Junction / Solder point)	$R_{\text{th JS}}^{[2]}$	165	$^{\circ}\text{C/W}$

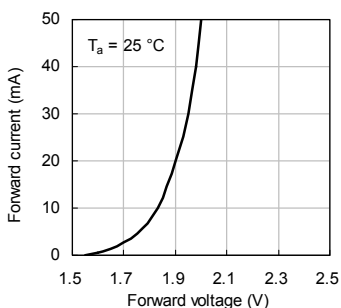
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{\text{th JA}}, R_{\text{th JS}}$ Results from mounting on PC board FR4 (pad size $\geq 16\text{ mm}^2$ per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

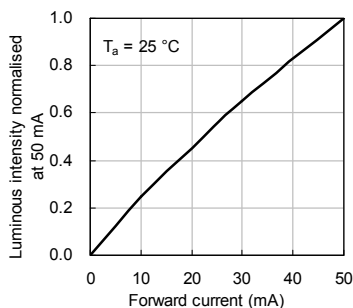
RELATIVE INTENSITY vs. WAVELENGTH



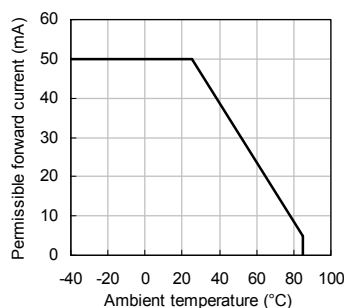
Forward Current vs. Forward Voltage



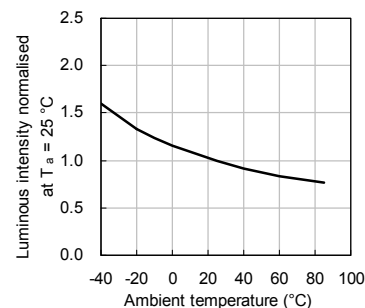
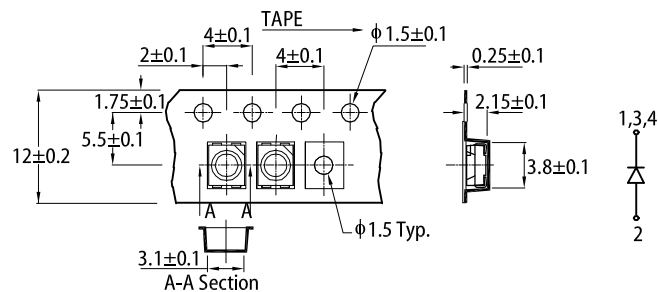
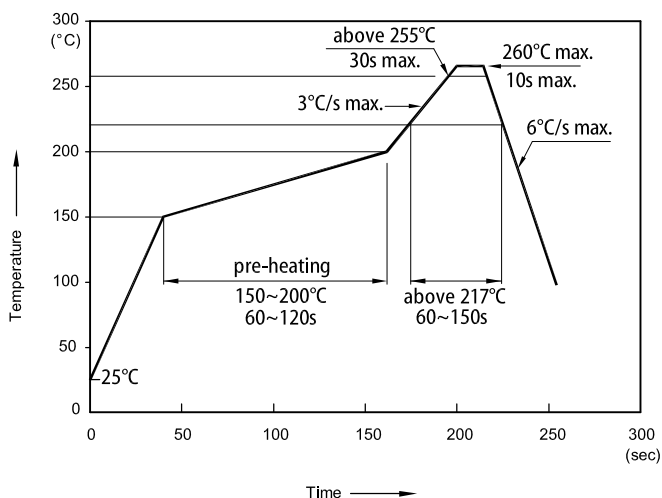
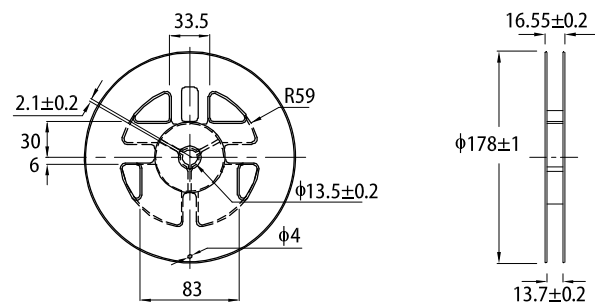
Luminous Intensity vs. Forward Current



Forward Current Derating Curve

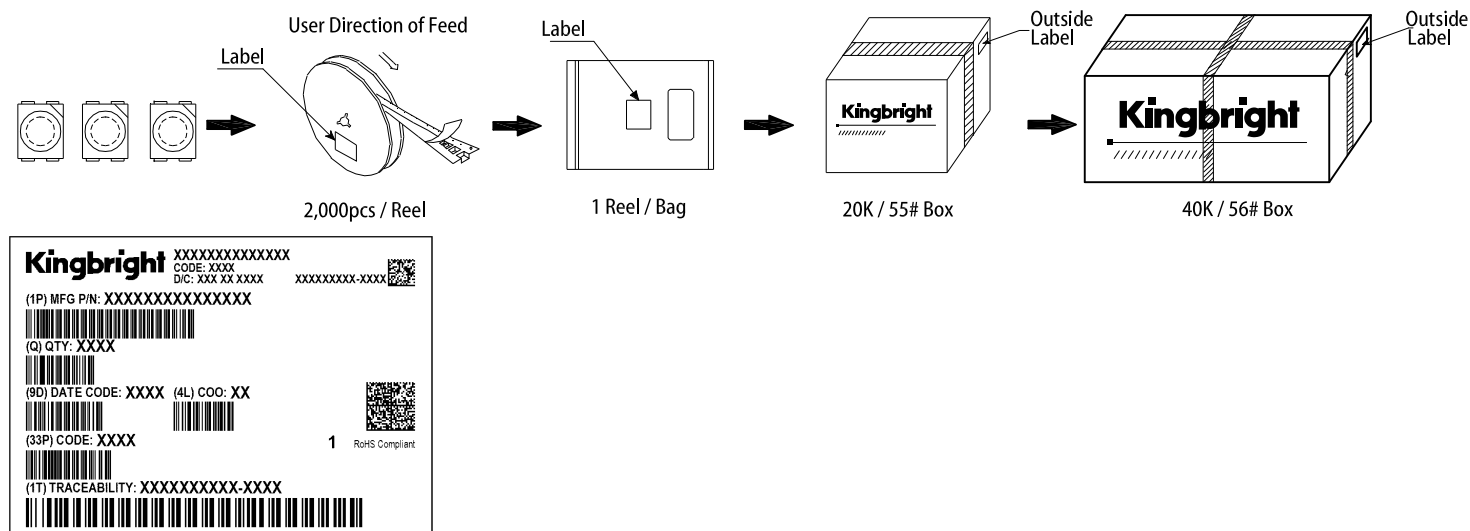


Luminous Intensity vs. Ambient Temperature

**TAPE SPECIFICATIONS** (units : mm)**REEL DIMENSION** (units : mm)

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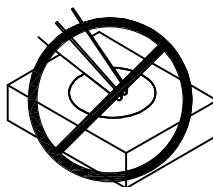
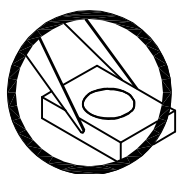
PACKING & LABEL SPECIFICATIONS



HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.
2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.
3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4-1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4-2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4-3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.
5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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